



**DMN2040UVT** 

## **Product Summary**

BV <sub>DSS</sub>	RDS(ON) Max	I <sub>D</sub> T <sub>A</sub> = +25°C
001/	$24m\Omega @ V_{GS} = 4.5V$	6.7A
20V	$32m\Omega @ V_{GS} = 2.5V$	5.8A

# **Description and Applications**

This new generation MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

- **DC-DC** Converters
- **Power Management Functions**
- Backlighting

### N-CHANNEL ENHANCEMENT MODE MOSFET

## **Features and Benefits**

- Low Input Capacitance
- Low On-Resistance
- Fast Switching Speed
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

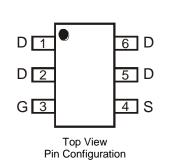
### **Mechanical Data**

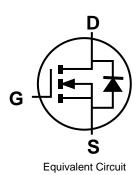
- Case: TSOT26
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Tin Finish Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.013 grams (Approximate)



TSOT26

Top View





## Ordering Information (Note 4)

	Part Number	Case	Packaging			
	DMN2040UVT-7	TSOT26	3,000/Tape & Reel			
DMN2040UVT-13 TSOT26 10,000/Tape & Ree						
Notes:	Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.					

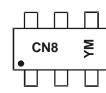
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**



CN8 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: F = 2018)M = Month (ex: 9 = September)

### Date Code Key

Duie Coue Rey												
Year	201	8	2019		2020	20	)21	2022		2023	1	2024
Code	F		G		Н			J		K		L
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



# Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage		V <sub>DSS</sub>	20	V	
Gate-Source Voltage		V <sub>GSS</sub>	±8	V	
Continuous Drain Current (Note 6) $V_{GS}$ = 4.5V	Steady State	$T_A = +25^{\circ}C$ $T_A = +75^{\circ}C$	ID	6.7 5.3	А
Maximum Body Diode Forward Current (Note 6)	•	I <sub>S</sub>	1.2	А	
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%		I <sub>DM</sub>	40	А	

# Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5)		PD	1.2	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	$R_{ ext{ heta}JA}$	104	°C/W
Total Power Dissipation (Note 6)		PD	1.6	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	$R_{ ext{ heta}}JA$	77	°C/W
Operating and Storage Temperature Range		T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C

# Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

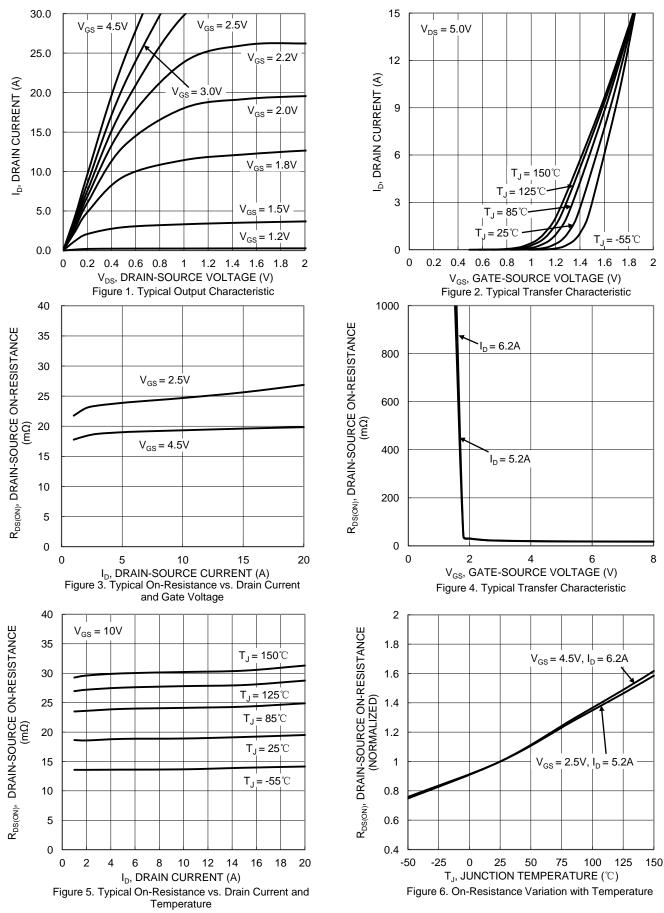
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)	Cymbol	WIIII	קעי	IIIdA	Onit	Test condition
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	20	_	_	V	$V_{GS} = 0V, I_{D} = 250\mu A$
Zero Gate Voltage Drain Current	IDSS	_	_	1	μA	$V_{DS} = 16V, V_{GS} = 0V$
Gate-Source Leakage	I <sub>GSS</sub>	_	—	±100	nA	$V_{GS} = \pm 8V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	0.4	—	1.5	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$
Static Drain-Source On-Resistance		_	18	24	mΩ	$V_{GS} = 4.5V, I_D = 6.2A$
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	—	24	32	11122	$V_{GS} = 2.5V, I_D = 5.2A$
Diode Forward Voltage	V <sub>SD</sub>	_	0.7	1.2	V	$V_{GS} = 0V, I_{S} = 1.3A$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	—	667	—		
Output Capacitance	Coss	_	91	—	pF	$V_{DS} = 10V, V_{GS} = 0V,$ f = 1.0MHz
Reverse Transfer Capacitance	C <sub>rss</sub>	_	83	_		
Gate Resistance	Rg	_	1.2	—	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Total Gate Charge	Qg	_	7.5	—		$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$
Gate-Source Charge	Qgs	_	0.8	_	nC	$V_{GS} = 4.5V, V_{DS} = 10V,$
Gate-Drain Charge	Q <sub>gd</sub>	_	2.5	_		I <sub>D</sub> = 8.2A
Turn-On Delay Time	t <sub>D(ON)</sub>	_	3.9	_		
Turn-On Rise Time	t <sub>R</sub>	_	5.1	_		$V_{DD} = 10V, V_{GS} = 4.5V,$
Turn-Off Delay Time	t <sub>D(OFF)</sub>	_	21	_	ns	$R_L = 10\Omega, R_g = 6\Omega$
Turn-Off Fall Time	t <sub>F</sub>	_	9.4	—	]	
Reverse Recovery Time	t <sub>RR</sub>	_	12		ns	L = 5.00 di/dt = 1000/up
Reverse Recovery Charge	Q <sub>RR</sub>	_	3.4	_	nC	I <sub>F</sub> = 5.0A, di/dt = 100A/μs

Notes:

Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
Device mounted on FR-4 substrate PC board, 2oz copper, with thermal vias to bottom layer 1inch square copper plate.
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to production testing.

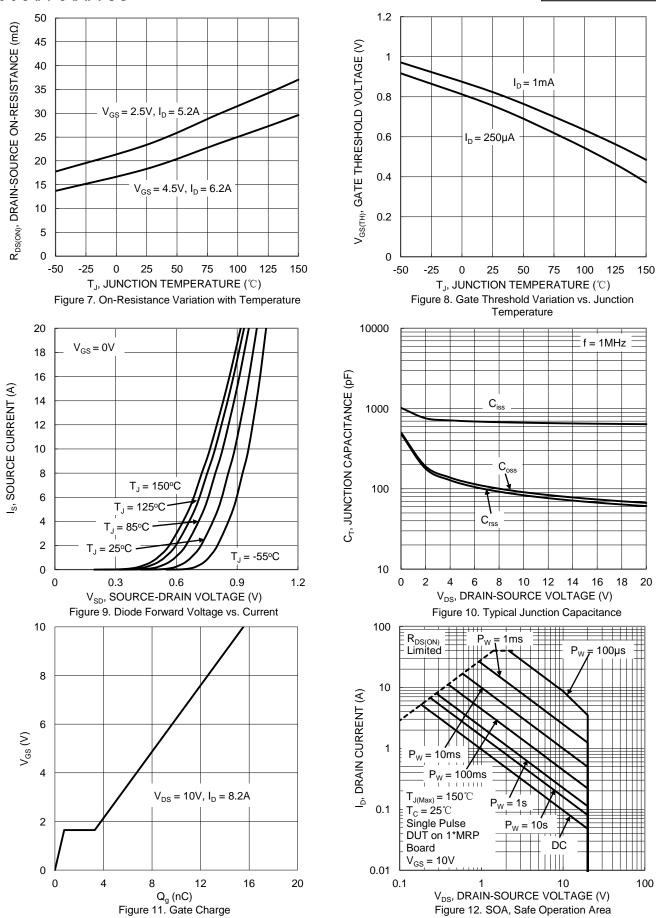


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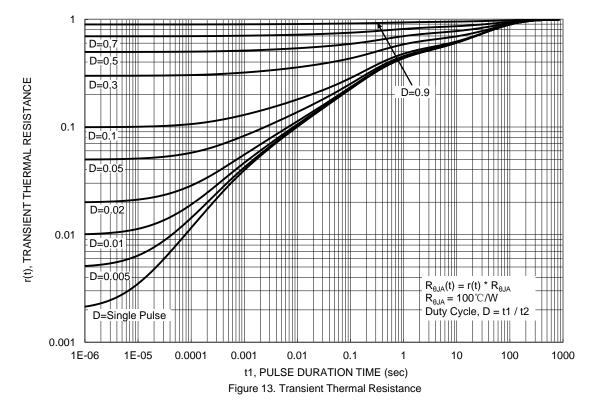


# DMN2040UVT



DMN2040UVT Document number: DS40946 Rev. 2 - 2



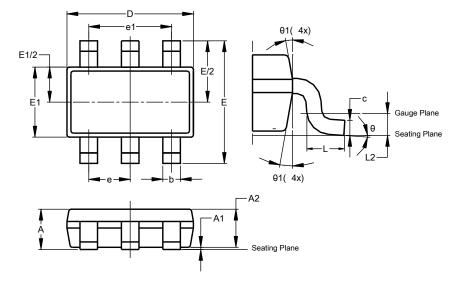




# **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

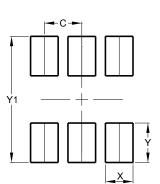
TSOT26



TSOT26							
Dim	Min	Max	Тур				
Α	-	1.00	-				
A1	0.010	0.100	-				
A2	0.840	0.900	-				
D	2.800	3.000	2.900				
ш	2	.800 BS	С				
E1	1.500 1.700 1.60		1.600				
b	0.300 0.450 -		-				
C	0.120	0.200	-				
е	0	.950 BS	С				
e1	1	.900 BS	С				
L	0.30	0.50	-				
L2	0.250 BSC						
θ	0°	8°	4°				
θ1	4°	12°	_				
A	All Dimensions in mm						

# Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



TSOT26

Dimensions	Value (in mm)
С	0.950
Х	0.700
Y	1.000
Y1	3.199



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